



Symbol	Count	Hole Size	Hole Length	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape
\$	61	0.300mm (11.81mil)	-	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
	2	0.600mm (23.62mil)	1.600mm (62.99mil)	РТН	Slot	Top Layer - Bottom Layer	Pad	Rounded
0	2	0.600mm (23.62mil)	2.100mm (82.68mil)	PTH	Slot	Top Layer - Bottom Layer	Pad	Rounded
∇	2	1.100mm (43.31mil)	-	РТН	Round	Top Layer - Bottom Layer	Pad	(Mixed)
0	3	3.000mm (118.11mil)	-	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded
	70 Total							
∇	2 3 70 Total	1.100mm (43.31mil)	, ,	РТН	Round	Top Layer - Bottom Layer	Pad	(Mixed)

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.

Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout

Layer	Name	Material	Material Thickness		Gerber	Board Layer Stack	
	Top Overlay				GTO		
	Top Solder	Solder Resist	0.010mm	3.5	GTS		
1	Top Layer		0.035mm		GTL		
	Dielectric1	FR-4 (7628)	0.180mm	4.2			
	Dielectric 2	FR-4 (7628)	0.180mm	4.2			
2	MidLayer1		0.035mm		G1		
	Core		0.710mm	4.2			
3	MidLayer2		0.035mm		G2		
	Dielectric 3	FR-4 (7628)	0.180mm	4.2			
	Dielectric 4	FR-4 (7628)	0.180mm	4.2			
4	Bottom Layer		0.035mm		GBL		
	Bottom Solder	Solder Resist	0.010mm	3.5	GBS		
	Bottom Overlay	·			GBO		

Total board thickness:

1.590mm













